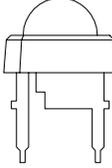


- Features:
- Bi-Colour
  - Water clear epoxy
  - Low thermal resistance copper leadframe
  - 4 leads with stand off
  - Class II ESD Rating

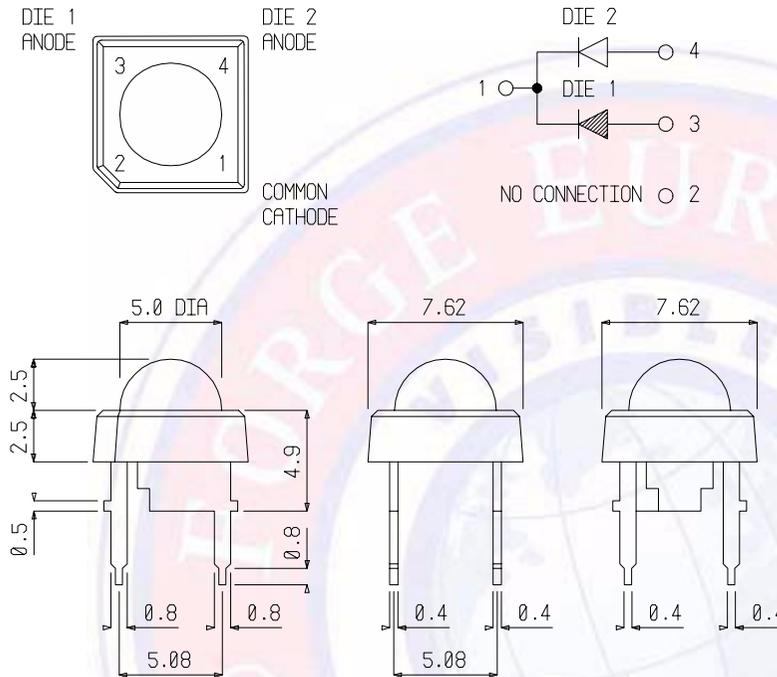
## Electro / Optical Characteristics $I_F = 20 \text{ mA}$ $T_a = 25^\circ \text{ C}$

Lamp Package	LED Part Number	Die Ref	Emitting Colour	Epoxy Type	Die Material	Wavelength		Forward Voltage $V_F$		Luminous intensity $I_V$		Viewing $\angle$ 20 $\frac{1}{2}$
						Peak $\lambda_p$	Dominant $\lambda_d$	typical	max	min	typical	
	FCL-P5DR078G03WCCI	1	Red	WC	AlGaInP	632	624	2.00	2.40	-	400	65
		2	Green		InGaN/SiC	518	525	3.70	4.20	-	400	
	FCL-P5DY109B12WCCI	1	Yellow	WC	AlGaInP	587	585	2.00	2.40	-	500	65
		2	Blue		InGaN/SiC	468	470	3.75	4.00		260	
7.6 x 7.6 mm	Units					nm		V		mcd per die	deg	

It is the responsibility of the customer to verify the suitability of the product for the application.

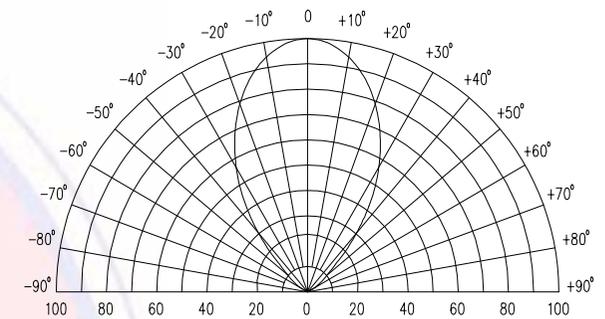
## Package Outline

Dimensions in mm  
Tol  $\pm 0.25$  mm  
unless stated



## Radiation Diagram

$T_a = 25^\circ\text{C}$



Relative angular intensity

### Note:

Due to manufacturing tolerances the maximum intensity position may deviate from the 0° point.

## Maximum Ratings per die $T_a = 25^\circ\text{C}$ ( Derate above 25° C )

Characteristic	Condition	Symbol	Rating
Pulse Forward Current	0.1 duty cycle @ 1KHz	$I_{FP}$	100
DC Forward Current		$I_F$	50
Reverse Voltage	$I_R = 10 \mu\text{A}$	$V_R$	10
Pulse Forward Current	0.1 duty cycle @ 1KHz	$I_{FP}$	100
DC Forward Current		$I_F$	35
Reverse Voltage	$I_R = 10 \mu\text{A}$	$V_R$	5
Operating Temperature		$T_{opr}$	- 20 to + 80
Storage Temperature		$T_{stg}$	- 20 to + 100
Lead soldering temperature	1.6 mm from body - max. 3 seconds		240

### Note

Consideration must be given to forward current levels at elevated temperatures when driving all dice simultaneously to ensure maximum efficiency over the life of the product.

Industry standard procedures regarding static must be observed when handling product produced with the following die material.

InGaN/SiC